



Mission: Disruptive radio solutions for 5G NR and beyond that enable superior mobile services

The Core Team

Experienced founder-led team with over 1bn units shipped over 12 products, a combined 250+ years industry experience at Broadcom, Nokia, Ericsson and Lucent and 4 previous exits



Manolis Frantzeskakis CEO

PhD, Univ. of Maryland, USA 20+ years in telecom & semiconductors

10+ patents

Previous: Broadcom, Intracom Telecom

Previous exits: 1



Georgios Sfikas CTO

PhD, Univ. of Surrey, UK

20+ years in design engineering and management

10+ patents

Previous: Broadcom, Lucent



Meir Doron VP of Business Development

BS, Haifa Technion Institute, Israel 20+ years marketing in high tech

Previous : Broadcom, Nokia-Siemens

Previous exits: 3



Konstantinos Vryssas VP of Engineering

PhD, National Technical U. of Athens, Greece

RF expert, Wi-Fi, 2G/3G/4G/5G cellular

20+ years RF & mmWave

Previous: Broadcom, Ericsson



Harry Contopanagos Director/ Antenna Tech

PhD, U. of Michigan at Ann Arbor, USA

25+ years antenna design

20+ patents, 80+ journal publications

Previous: Broadcom, HRL, Demokritus Institute





Partners





GlobalFoundries

TTM Technologies,

The Problem Unprecedented Cost for 5G massive MIMO Many radios High cost **** **** **** **** **** * * * * * * × **x** × × **** * * I radio path costs about €200 **** **** **** **** **** **** **** **** * * * * **** **** **** * * * * * * * * I Radio Unit has 32/64/128 paths Radios x 10 **** Consumption x 10 * * * * * * * * Lower Coverage * * **** **** **** * * * * * * * * * * **** * * * * **** * * * * **** **** **** **Operators are** desperately looking for 5G / 5.5G **4G LTE** affordable MIMO solutions Skyrocketed CAPEX (€37B by 2028) + OPEX

SEM1

ARGO

World's first C-Band Printed Antenna



Ultra-Slim Antenna Array

PR on April 25, 2024



HFSS

C-Band EU/India/ -5 USA, CBRS -10 -15 (g) -20 -2-25 -30 -35 -40 45 30 31 32 33 34 35 36 37 38 39 40 41 42 43 44 45 Frequency (GHz)

World's first Single-Board Active Antenna Module



Top-Side Cooling & Printed Antenna



Promoted as "Digital Airfast" by NXP

Scaling, Simplicity, Integration, Cost Effectiveness



What comes next? → Smart RFIC Enhancing Flexibility



•Dynamic sectorization

•Tilt control without moving parts

Smart RFIC to be embedded in the active antenna module



Improve: Coverage – Power - Lifetime – Volume – Weight \rightarrow Reduce: CAPEX - OPEX

The Market Opportunity



SEM1 Market pressure in combination with Open-RAN maturity has created a thriving ecosystem that enables best of breed to

ARGO

• Capitalising on the opportunity would enable the O-RAN market to reach €3B (TAM)

compete with large incumbents for Service Provider deployments

- 5G infrastructure antenna and RFIC semiconductor market valued at ${\rm {\small \small C0.7B}}$
- Partnering discussions with visibility of early product deployment are already advancing in a number of markets



Value Proposition

- Reduction of Radio Complexity
 - Fewer modules, less digital supervision
 - Reduces radio parts, volume and weight (x2 or more)
- Cost Reduction (CAPEX)
 - Up to 25% reduction in deployment cost
 - Radio cost from ~6000 to ~4400€
- Enhanced Coverage
 - RFIC facilitates 25% better coverage
 - More reliable service, even in weak signal areas
- Power Efficiency (OPEX)
 - Reduces power consumption by up to 20%
 - Less power losses, lower OPEX
- Flexibility
 - Can trade coverage, power, life-time, OPEX, CAPEX
 - Expand options on radio dimensioning and selection



ARGO

Radio BOM using Argo components



European Innovation Council Award



EIC Project Milestones

- Development finalization and manufacturing of the smart RFIC
- Validate our Active Antenna Catalyst module by integrating it into customer products
- Ramping up our marketing efforts for Argo Active
 Antenna Catalyst module and scale-up globally



We are your RF partner for your sub-10GHz radio

Thank You



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